

131,072-WORD BY 8-BIT STATIC RAM

### DESCRIPTION

The TC55V1001AFI/AFTI/ATRI/ASTI/ASRI is a 1,048,576-bit static random access memory (SRAM) organized as 131,072 words by 8 bits. Fabricated using Toshiba's CMOS Silicon gate process technology, this device operates from a single 2.7 to 3.6 V power supply. Advanced circuit technology provides both high speed and low power at an operating current of 3 mA/MHz and a minimum cycle time of 85 ns. It is automatically placed in low-power mode at 0.5  $\mu$ A standby current (L-Version at  $V_{DD}=3V$ ,  $T_a=25^\circ C$ ) when chip enable ( $\overline{CE1}$ ) is asserted high or ( $\overline{CE2}$ ) is asserted low. There are three control inputs.  $\overline{CE1}$  and  $\overline{CE2}$  are used to select the device and for data retention control, and output enable ( $\overline{OE}$ ) provides fast memory access. This device is well suited to various microprocessor system applications where high speed, low power and battery backup are required. The TC55V1001AFI/AFTI/ATRI/ASTI/ASRI is available in a plastic 32-pin small-outline package (SOP) and normal and reverse pinout plastic 32-pin thin-small-outline package (TSOP).

### FEATURES

- Low-power dissipation  
Operating: 10.8 mW/MHz (typical)
- Single power supply voltage of 2.7 to 3.6 V
- Power down features using  $\overline{CE1}$  and  $\overline{CE2}$ .
- Data retention supply voltage of 2 to 3.6 V
- Direct TTL compatibility for all inputs and outputs
- Wide operating temperature range of  $-40^\circ$  to  $85^\circ C$
- Standby current ( $T_a=25^\circ C$  maximum)

|      | TC55V1001AFI/AFTI/ATRI/ASTI/ASRI |             |
|------|----------------------------------|-------------|
|      | -85, -10                         | -85L, -10L  |
| 3.6V | 3 $\mu$ A                        | 0.9 $\mu$ A |
| 3.0V | 1 $\mu$ A                        | 0.5 $\mu$ A |

- Access Times (maximum):

|                              | TC55V1001AFI/AFTI/ATRI/ASTI/ASRI |           |
|------------------------------|----------------------------------|-----------|
|                              | -85, -85L                        | -10, -10L |
| Access Time                  | 85ns                             | 100ns     |
| $\overline{CE1}$ Access Time | 85ns                             | 100ns     |
| $\overline{CE2}$ Access Time | 85ns                             | 100ns     |
| $\overline{OE}$ Access Time  | 45ns                             | 50ns      |

- Packages:

SOP32-P-525-1.27 (AFI) (Weight: 1.04 g typ)  
 TSOP I 32-P-0820-0.50 (AFTI) (Weight: 0.34 g typ)  
 TSOP I 32-P-0820-0.50A (ATRI) (Weight: 0.34 g typ)  
 TSOP I 32-P-0.50 (ASTI) (Weight: 0.24 g typ)  
 TSOP I 32-P-0.50A (ASRI) (Weight: 0.24 g typ)

### PIN ASSIGNMENT (TOP VIEW)

#### ○ 32 PIN SOP

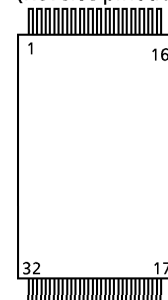
|      |    |    |                  |
|------|----|----|------------------|
| NC   | 1  | 32 | $V_{DD}$         |
| A16  | 2  | 31 | A15              |
| A14  | 3  | 30 | $\overline{CE2}$ |
| A12  | 4  | 29 | R/W              |
| A7   | 5  | 28 | A13              |
| A6   | 6  | 27 | A8               |
| A5   | 7  | 26 | A9               |
| A4   | 8  | 25 | A11              |
| A3   | 9  | 24 | $\overline{OE}$  |
| A2   | 10 | 23 | A10              |
| A1   | 11 | 22 | $\overline{CE1}$ |
| A0   | 12 | 21 | I/O8             |
| I/O1 | 13 | 20 | I/O7             |
| I/O2 | 14 | 19 | I/O6             |
| I/O3 | 15 | 18 | I/O5             |
| GND  | 16 | 17 | I/O4             |

#### ○ 32 PIN TSOP

(Normal pinout)



(Reverse pinout)



### PIN NAMES

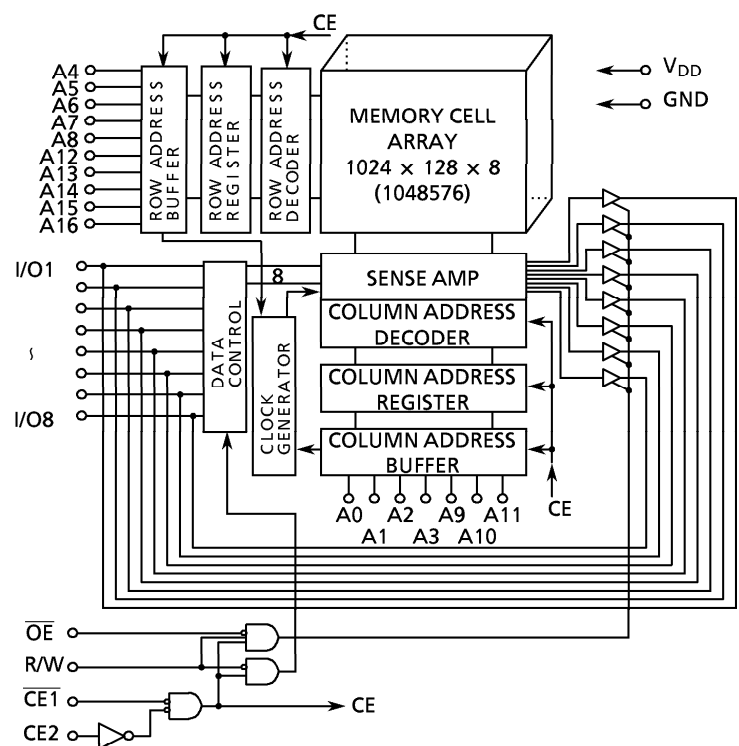
|                                     |                    |
|-------------------------------------|--------------------|
| A0 to A16                           | Address Inputs     |
| R/W                                 | Read/Write Control |
| $\overline{OE}$                     | Output Enable      |
| $\overline{CE1}$ , $\overline{CE2}$ | Chip Enable        |
| I/O1 to I/O8                        | Data Input/Output  |
| $V_{DD}$                            | Power              |
| GND                                 | Ground             |
| NC                                  | No Connection      |

|          |                 |                |                |                 |      |                  |                 |          |      |                 |                 |                 |                |                  |                 |                 |
|----------|-----------------|----------------|----------------|-----------------|------|------------------|-----------------|----------|------|-----------------|-----------------|-----------------|----------------|------------------|-----------------|-----------------|
| Pin No.  | 1               | 2              | 3              | 4               | 5    | 6                | 7               | 8        | 9    | 10              | 11              | 12              | 13             | 14               | 15              | 16              |
| Pin Name | A <sub>11</sub> | A <sub>9</sub> | A <sub>8</sub> | A <sub>13</sub> | R/W  | $\overline{CE2}$ | A <sub>15</sub> | $V_{DD}$ | NC   | A <sub>16</sub> | A <sub>14</sub> | A <sub>12</sub> | A <sub>7</sub> | A <sub>6</sub>   | A <sub>5</sub>  | A <sub>4</sub>  |
| Pin No.  | 17              | 18             | 19             | 20              | 21   | 22               | 23              | 24       | 25   | 26              | 27              | 28              | 29             | 30               | 31              | 32              |
| Pin Name | A <sub>3</sub>  | A <sub>2</sub> | A <sub>1</sub> | A <sub>0</sub>  | I/O1 | I/O2             | I/O3            | GND      | I/O4 | I/O5            | I/O6            | I/O7            | I/O8           | $\overline{CE1}$ | A <sub>10</sub> | $\overline{OE}$ |

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**BLOCK DIAGRAM**



**OPERATION MODE**

| MODE             | CE1 | CE2 | OE | R/W | I/O1 to I/O8     | POWER            |
|------------------|-----|-----|----|-----|------------------|------------------|
| Read             | L   | H   | L  | H   | D <sub>OUT</sub> | I <sub>DDO</sub> |
| Write            | L   | H   | x  | L   | D <sub>IN</sub>  | I <sub>DDO</sub> |
| Outputs Disabled | L   | H   | H  | H   | High-Z           | I <sub>DDO</sub> |
| Standby          | H   | x   | x  | x   | High-Z           | I <sub>DDS</sub> |
|                  | x   | L   | x  | x   | High-Z           | I <sub>DDS</sub> |

Note: x = don't care. H = logic high. L = logic low.

**ABSOLUTE MAXIMUM RATINGS**

| SYMBOL              | RATING                       | VALUE                          | UNIT |
|---------------------|------------------------------|--------------------------------|------|
| V <sub>DD</sub>     | Power Supply Voltage         | - 0.3 to 4.6                   | V    |
| V <sub>IN</sub>     | Input Voltage                | - 0.3* to 4.6                  | V    |
| V <sub>I/O</sub>    | Input/Output Voltage         | - 0.5 to V <sub>DD</sub> + 0.5 | V    |
| P <sub>D</sub>      | Power Dissipation            | 0.8                            | W    |
| T <sub>solder</sub> | Soldering Temperature (10 s) | 260                            | °C   |
| T <sub>strg.</sub>  | Storage Temperature          | - 55 to 150                    | °C   |
| T <sub>opr.</sub>   | Operating Temperature        | - 40 to 85                     | °C   |

\* - 3.0 V when measured at a pulse width of 50 ns

\*\* SOP

DC RECOMMENDED OPERATING CONDITIONS ( $T_a = -40^\circ$  to  $85^\circ\text{C}$ )

| SYMBOL   | PARAMETER                     | 2.7 to 3.6 V |     |                | UNIT |
|----------|-------------------------------|--------------|-----|----------------|------|
|          |                               | MIN          | TYP | MAX            |      |
| $V_{DD}$ | Power Supply Voltage          | 2.7          | –   | 3.6            | V    |
| $V_{IH}$ | Input High Voltage            | 2.2          | –   | $V_{DD} + 0.3$ |      |
| $V_{IL}$ | Input Low Voltage             | $-0.3^*$     | –   | 0.6            |      |
| $V_{DH}$ | Data Retention Supply Voltage | 2.0          | –   | 3.6            |      |

\*  $-3.0\text{ V}$  when measured at a pulse width of 50 nsDC CHARACTERISTICS ( $T_a = -40^\circ$  to  $85^\circ\text{C}$ ,  $V_{DD} = 2.7$  to  $3.6\text{ V}$ )

| SYMBOL                      | PARAMETER                                                                                                                                                  | TEST CONDITION                                                                                                                                             |                                    |                    |            | MIN   | TYP | MAX   | UNIT |
|-----------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------|--------------------|------------|-------|-----|-------|------|
| I <sub>IL</sub>             | Input Leakage Current                                                                                                                                      | V <sub>IN</sub> = 0 V to V <sub>DD</sub>                                                                                                                   |                                    |                    |            | –     | –   | ± 1.0 | μA   |
| I <sub>OH</sub>             | Output High Current                                                                                                                                        | V <sub>OH</sub> = V <sub>DD</sub> – 0.5 V                                                                                                                  |                                    |                    |            | – 0.5 | –   | –     | mA   |
| I <sub>OL</sub>             | Output Low Current                                                                                                                                         | V <sub>OL</sub> = 0.4 V                                                                                                                                    |                                    |                    |            | 2.1   | –   | –     | mA   |
| I <sub>LO</sub>             | Output Leakage Current                                                                                                                                     | CE1 = V <sub>IH</sub> or CE2 = V <sub>IL</sub> or R/W = V <sub>IL</sub> or<br>OE = V <sub>IH</sub> , V <sub>OUT</sub> = 0 V to V <sub>DD</sub>             |                                    |                    |            | –     | –   | ± 1.0 | μA   |
| I <sub>DDO1</sub>           | Operating Current                                                                                                                                          | CE1 = V <sub>IL</sub> and CE2 = V <sub>IH</sub> and<br>R/W = V <sub>IH</sub> , I <sub>OUT</sub> = 0 mA<br>Other Input = V <sub>IH</sub> /V <sub>IL</sub>   | V <sub>DD</sub> =<br>3 V ± 10%     | T <sub>cycle</sub> | min        | –     | –   | 35    | mA   |
| 1 μs                        |                                                                                                                                                            |                                                                                                                                                            |                                    |                    | –          | –     | 10  |       |      |
| I <sub>DDO2</sub>           |                                                                                                                                                            | CE1 = 0.2 V and<br>CE2 = V <sub>DD</sub> – 0.2 V<br>R/W = V <sub>DD</sub> – 0.2 V, I <sub>OUT</sub> = 0 mA<br>Other Inputs = V <sub>DD</sub> – 0.2 V/0.2 V | V <sub>DD</sub> =<br>3.3 V ± 0.3 V | T <sub>cycle</sub> | min        | –     | –   | 40    |      |
|                             |                                                                                                                                                            |                                                                                                                                                            |                                    |                    | 1 μs       | –     | –   | 12    |      |
| I <sub>DDO2</sub>           | CE1 = 0.2 V and<br>CE2 = V <sub>DD</sub> – 0.2 V<br>R/W = V <sub>DD</sub> – 0.2 V, I <sub>OUT</sub> = 0 mA<br>Other Inputs = V <sub>DD</sub> – 0.2 V/0.2 V | V <sub>DD</sub> =<br>3 V ± 10%                                                                                                                             | T <sub>cycle</sub>                 | min                | –          | –     | 30  |       |      |
|                             |                                                                                                                                                            |                                                                                                                                                            |                                    | 1 μs               | –          | –     | 5   |       |      |
| I <sub>DDO2</sub>           | CE1 = 0.2 V and<br>CE2 = V <sub>DD</sub> – 0.2 V<br>R/W = V <sub>DD</sub> – 0.2 V, I <sub>OUT</sub> = 0 mA<br>Other Inputs = V <sub>DD</sub> – 0.2 V/0.2 V | V <sub>DD</sub> =<br>3.3 V ± 0.3 V                                                                                                                         | T <sub>cycle</sub>                 | min                | –          | –     | 35  |       |      |
|                             |                                                                                                                                                            |                                                                                                                                                            |                                    | 1 μs               | –          | –     | 6   |       |      |
| I <sub>DDs1</sub>           | Standby Current                                                                                                                                            | CE1 = V <sub>IH</sub> or CE2 = V <sub>IL</sub>                                                                                                             |                                    |                    |            | –     | –   | 2     | mA   |
| I <sub>DDs2</sub><br>(Note) |                                                                                                                                                            | CE1 = V <sub>DD</sub> – 0.2 V<br>or CE2 = 0.2 V<br>V <sub>DD</sub> = 2.0 to 3.6 V                                                                          | V <sub>DD</sub> =<br>3V ± 10%      | Ta = 25°C          | –85, –10   | –     | 1   | 2     | μA   |
|                             |                                                                                                                                                            |                                                                                                                                                            |                                    |                    | –85L, –10L | –     | 0.5 | 0.7   |      |
|                             |                                                                                                                                                            |                                                                                                                                                            |                                    | Ta = – 40° to 85°C | –85, –10   | –     | –   | 40    |      |
|                             |                                                                                                                                                            |                                                                                                                                                            |                                    |                    | –85L, –10L | –     | –   | 25    |      |
|                             |                                                                                                                                                            |                                                                                                                                                            | V <sub>DD</sub> =<br>3.3V ± 0.3V   | Ta = 25°C          | –85, –10   | –     | 2   | 3     |      |
|                             |                                                                                                                                                            |                                                                                                                                                            |                                    |                    | –85L, –10L | –     | 0.7 | 0.9   |      |
|                             |                                                                                                                                                            |                                                                                                                                                            |                                    | Ta = – 40° to 85°C | –85, –10   | –     | –   | 45    |      |
|                             |                                                                                                                                                            |                                                                                                                                                            |                                    |                    | –85L, –10L | –     | –   | 30    |      |
|                             |                                                                                                                                                            | V <sub>DD</sub> = 3V                                                                                                                                       | Ta = 25°C                          | –85, –10           | –          | –     | 1   |       |      |
|                             |                                                                                                                                                            |                                                                                                                                                            |                                    | –85L, –10L         | –          | –     | 0.5 |       |      |
|                             |                                                                                                                                                            |                                                                                                                                                            | Ta = – 40° to 40°C                 | –85, –10           | –          | –     | 3   |       |      |
|                             |                                                                                                                                                            |                                                                                                                                                            |                                    | –85L, –10L         | –          | –     | 2   |       |      |
|                             |                                                                                                                                                            |                                                                                                                                                            | Ta = – 40° to 85°C                 | –85, –10           | –          | –     | 35  |       |      |
|                             |                                                                                                                                                            |                                                                                                                                                            |                                    | –85L, –10L         | –          | –     | 20  |       |      |

Note: In standby mode with  $\overline{CE1} \geq V_{DD} - 0.2\text{ V}$ , these limits are assured for the condition  $CE2 \geq V_{DD} - 0.2\text{ V}$  or  $CE2 \leq 0.2\text{ V}$ .CAPACITANCE ( $T_a = 25^\circ\text{C}$ ,  $f = 1\text{ MHz}$ )

| SYMBOL    | PARAMETER          | TEST CONDITION         | MAX | UNIT |
|-----------|--------------------|------------------------|-----|------|
| $C_{IN}$  | Input Capacitance  | $V_{IN} = \text{GND}$  | 10  | pF   |
| $C_{OUT}$ | Output Capacitance | $V_{OUT} = \text{GND}$ | 10  |      |

Note: This parameter is periodically sampled and is not 100% tested.

**AC CHARACTERISTICS AND OPERATING CONDITIONS** ( $T_a = -40^\circ$  to  $85^\circ\text{C}$ ,  $V_{DD} = 2.7$  to  $3.6\text{ V}$ )

**READ CYCLE**

| SYMBOL           | PARAMETER                           | TC55V1001AFI/AFTI/ATRI/ASTI/ASRI |     |           |     | UNIT |
|------------------|-------------------------------------|----------------------------------|-----|-----------|-----|------|
|                  |                                     | -85, -85L                        |     | -10, -10L |     |      |
|                  |                                     | MIN                              | MAX | MIN       | MAX |      |
| t <sub>RC</sub>  | Read Cycle Time                     | 85                               | –   | 100       | –   | ns   |
| t <sub>ACC</sub> | Address Access Time                 | –                                | 85  | –         | 100 |      |
| t <sub>CO1</sub> | Chip Enable (CE1) Access Time       | –                                | 85  | –         | 100 |      |
| t <sub>CO2</sub> | Chip Enable (CE2) Access Time       | –                                | 85  | –         | 100 |      |
| t <sub>OE</sub>  | Output Enable Access Time           | –                                | 45  | –         | 50  |      |
| t <sub>COE</sub> | Chip Enable Low to Output Active    | 5                                | –   | 5         | –   |      |
| t <sub>OEE</sub> | Output Enable Low to Output Active  | 0                                | –   | 0         | –   |      |
| t <sub>OD</sub>  | Chip Enable High to Output High-Z   | –                                | 35  | –         | 40  |      |
| t <sub>ODO</sub> | Output Enable High to Output High-Z | –                                | 35  | –         | 40  |      |
| t <sub>OH</sub>  | Output Data Hold Time               | 10                               | –   | 10        | –   |      |

**WRITE CYCLE**

| SYMBOL           | PARAMETER                   | TC55V1001AFI/AFTI/ATRI/ASTI/ASRI |     |           |     | UNIT |
|------------------|-----------------------------|----------------------------------|-----|-----------|-----|------|
|                  |                             | -85, -85L                        |     | -10, -10L |     |      |
|                  |                             | MIN                              | MAX | MIN       | MAX |      |
| t <sub>WC</sub>  | Write Cycle Time            | 85                               | –   | 100       | –   | ns   |
| t <sub>WP</sub>  | Write Pulse Width           | 60                               | –   | 60        | –   |      |
| t <sub>CW</sub>  | Chip Enable to End of Write | 75                               | –   | 80        | –   |      |
| t <sub>AS</sub>  | Address Setup Time          | 0                                | –   | 0         | –   |      |
| t <sub>WR</sub>  | Write Recovery Time         | 0                                | –   | 0         | –   |      |
| t <sub>ODW</sub> | R/W Low to Output High-Z    | –                                | 35  | –         | 40  |      |
| t <sub>OEW</sub> | R/W High to Output Active   | 0                                | –   | 0         | –   |      |
| t <sub>DS</sub>  | Data Setup Time             | 35                               | –   | 40        | –   |      |
| t <sub>DH</sub>  | Data Hold Time              | 0                                | –   | 0         | –   |      |

**AC TEST CONDITIONS**

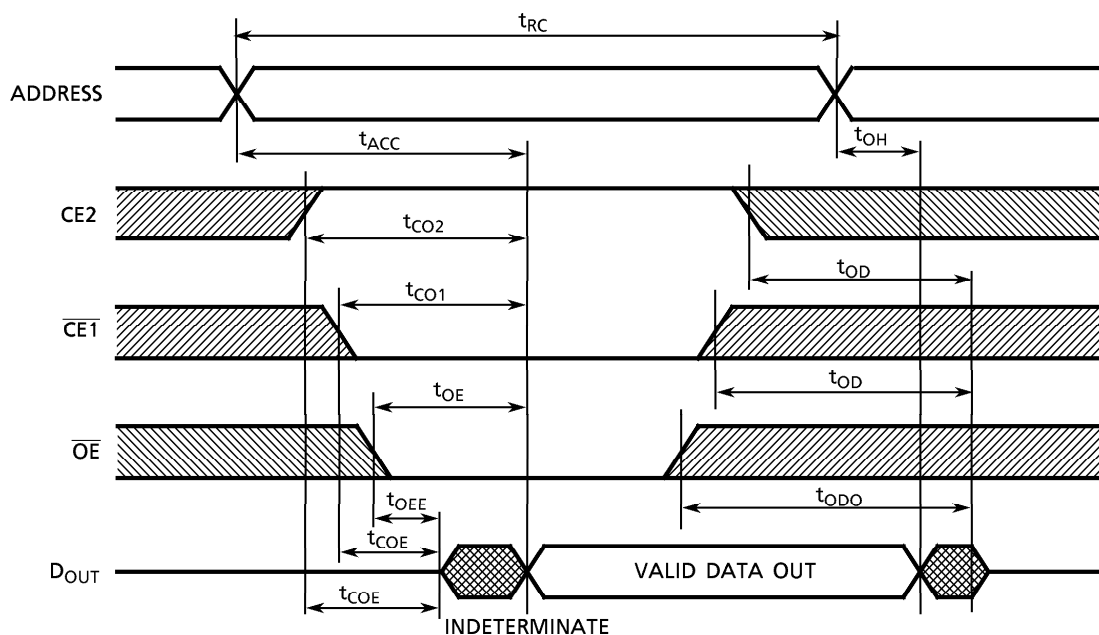
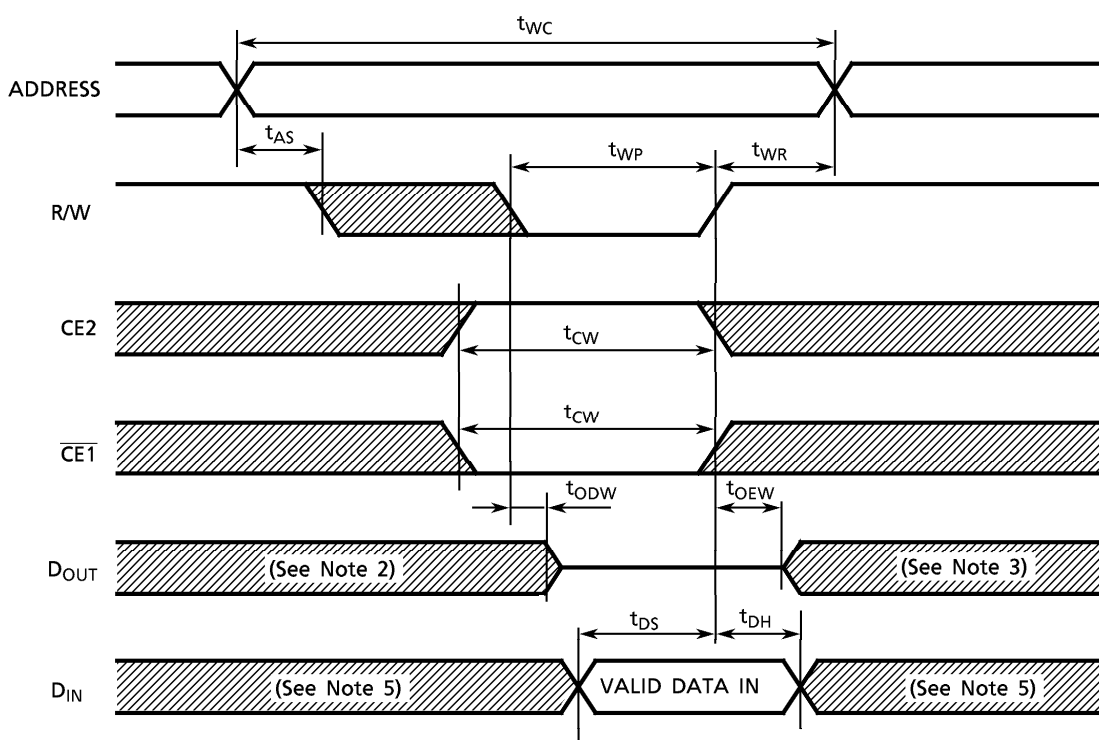
Output load: 100 pF + one TTL gate

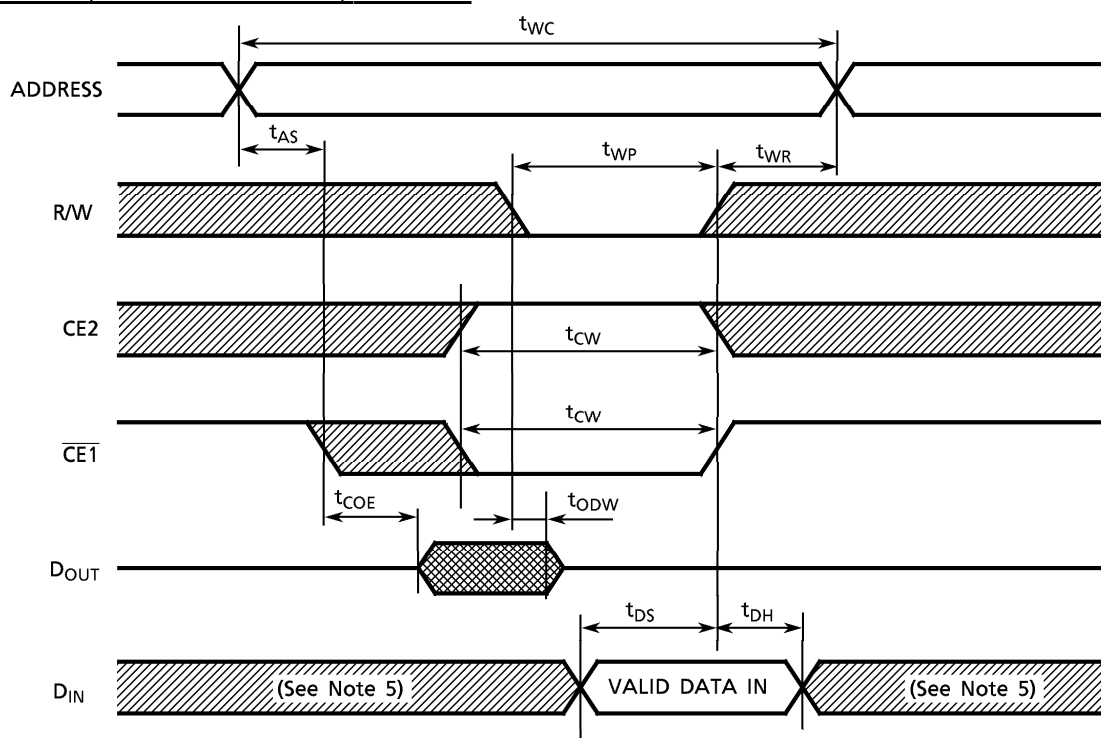
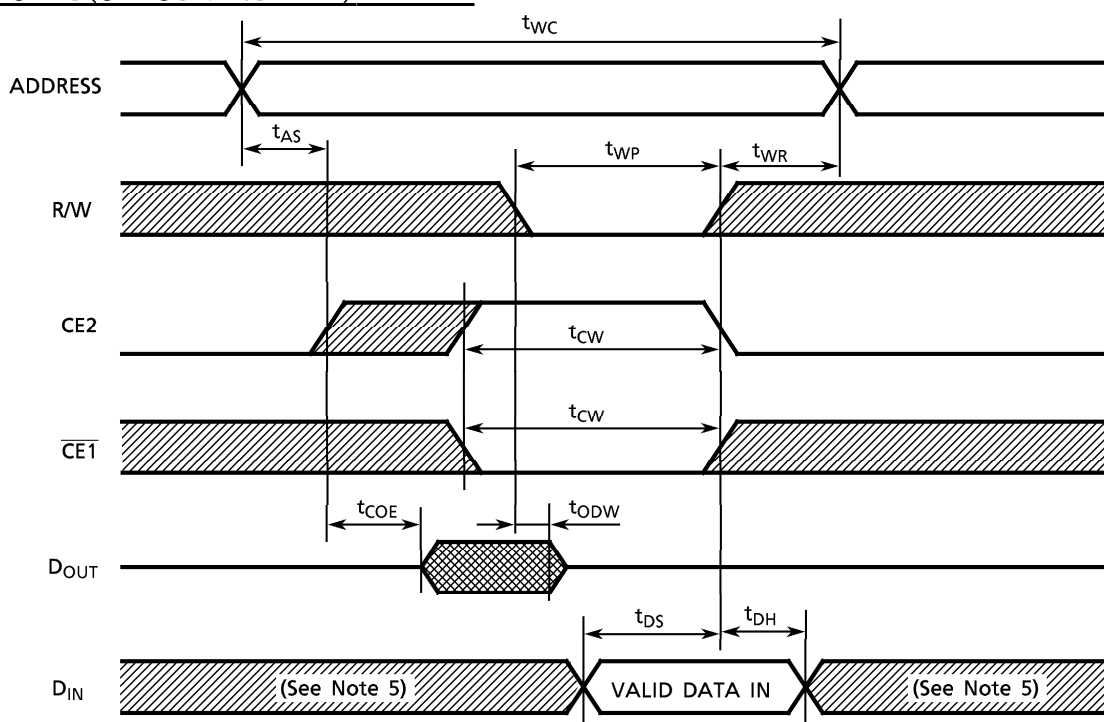
Input pulse level: 0.4 V, 2.4 V

Timing measurements: 1.5 V

Reference level: 1.5 V

$t_R$ ,  $t_F$ : 5 ns

**TIMING DIAGRAMS**
**READ CYCLE (See Note 1)**

**WRITE CYCLE 1 (R/W CONTROLLED) (See Note 4)**


**WRITE CYCLE 2 ( $\overline{\text{CE1}}$  CONTROLLED) (See Note 4)**

**WRITE CYCLE 3 (CE2 CONTROLLED) (See Note 4)**


Note: (1) R/W remains HIGH for the read cycle.

(2) If  $\overline{CE1}$  goes LOW (or CE2 goes HIGH) coincident with or after R/W goes LOW, the outputs will remain at high impedance.

(3) If  $\overline{CE1}$  goes HIGH (or CE2 goes LOW) coincident with or before R/W goes HIGH, the outputs will remain at high impedance.

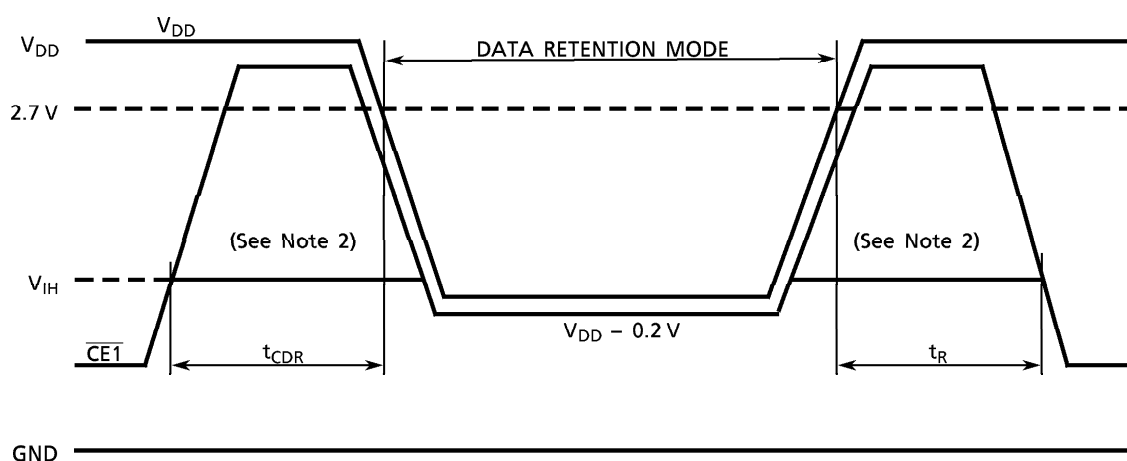
(4) If  $\overline{OE}$  is HIGH during the write cycle, the outputs will remain at high impedance.

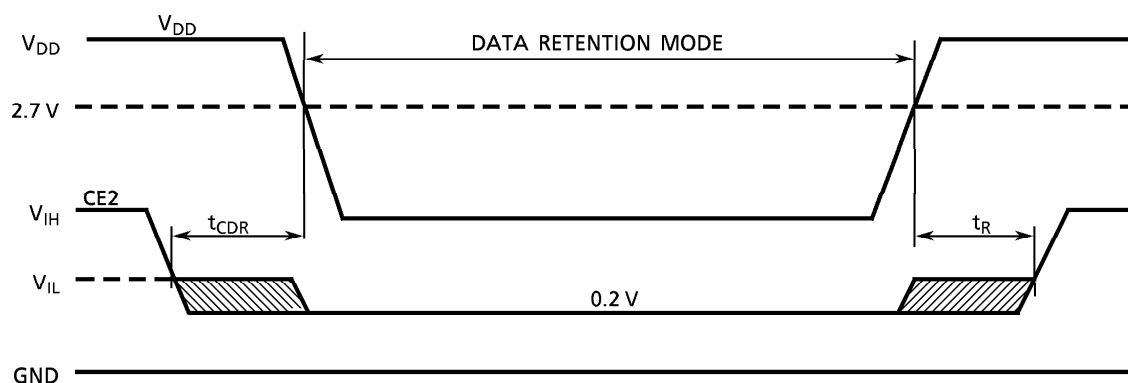
(5) Because I/O signals may be in the output state at this time, input signals of reverse polarity must not be applied.

### DATA RETENTION CHARACTERISTICS (Ta = -40° to 85°C)

| SYMBOL            | PARAMETER                                 |                        |                    |            | MIN | TYP | MAX | UNIT |
|-------------------|-------------------------------------------|------------------------|--------------------|------------|-----|-----|-----|------|
| V <sub>DH</sub>   | Data Retention Supply Voltage             |                        |                    |            | 2.0 | –   | 3.6 | V    |
| I <sub>DD52</sub> | Standby Current                           | V <sub>DH</sub> = 3.0V | Ta = – 40° to 40°C | –85, –10   | –   | –   | 3   | μA   |
|                   |                                           |                        |                    | –85L, –10L | –   | –   | 2   |      |
|                   |                                           | V <sub>DH</sub> = 3.6V | Ta = – 40° to 85°C | –85, –10   | –   | –   | 35  |      |
|                   |                                           |                        |                    | –85L, –10L | –   | –   | 20  |      |
|                   |                                           |                        |                    | –85, –10   | –   | –   | 45  |      |
|                   |                                           |                        |                    | –85L, –10L | –   | –   | 30  |      |
| t <sub>CDR</sub>  | Chip Deselect to Data Retention Mode Time |                        |                    |            | 0   | –   | –   | nS   |
| t <sub>R</sub>    | Recovery Time                             |                        |                    |            | 5   | –   | –   | mS   |

### CE1 CONTROLLED DATA RETENTION MODE (See Note 1)



CE2 CONTROLLED DATA RETENTION MODE (See Note 3)

Note: (1) In  $\overline{CE1}$  controlled data retention mode, minimum standby current mode is entered when

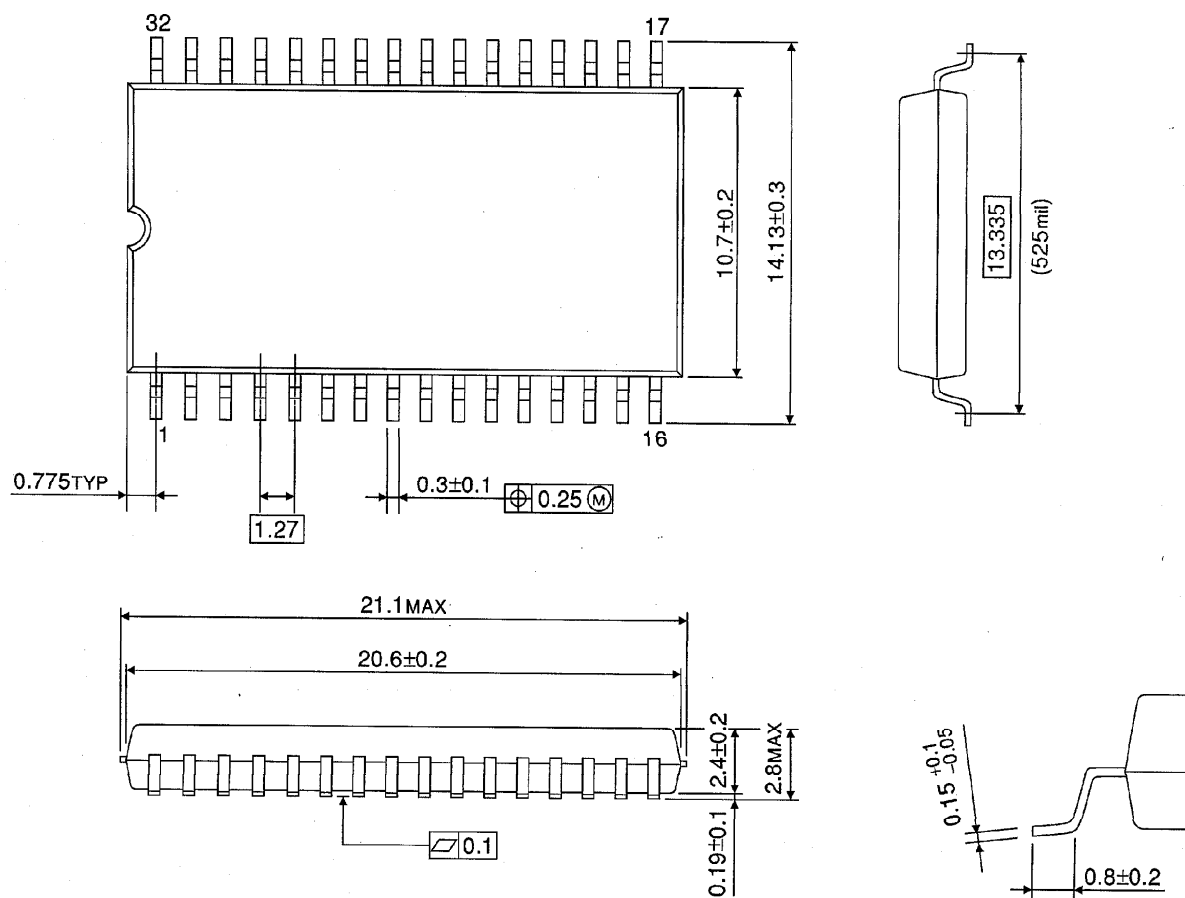
$$\overline{CE2} \leq 0.2 \text{ V or } \overline{CE2} \geq V_{DD} - 0.2 \text{ V.}$$

(2) When  $\overline{CE1}$  is operating at the  $V_{IH}$  level (2.2 V), the operating current is given by  $I_{DDSI}$  during the transition of  $V_{DD}$  from 3.6 to 2.4 V.

(3) In  $\overline{CE2}$  controlled data retention mode, minimum standby current mode is entered when  $\overline{CE2} \leq 0.2 \text{ V}$ .

**PACKAGE DIMENSIONS (SOP32-P-525-1.27)**

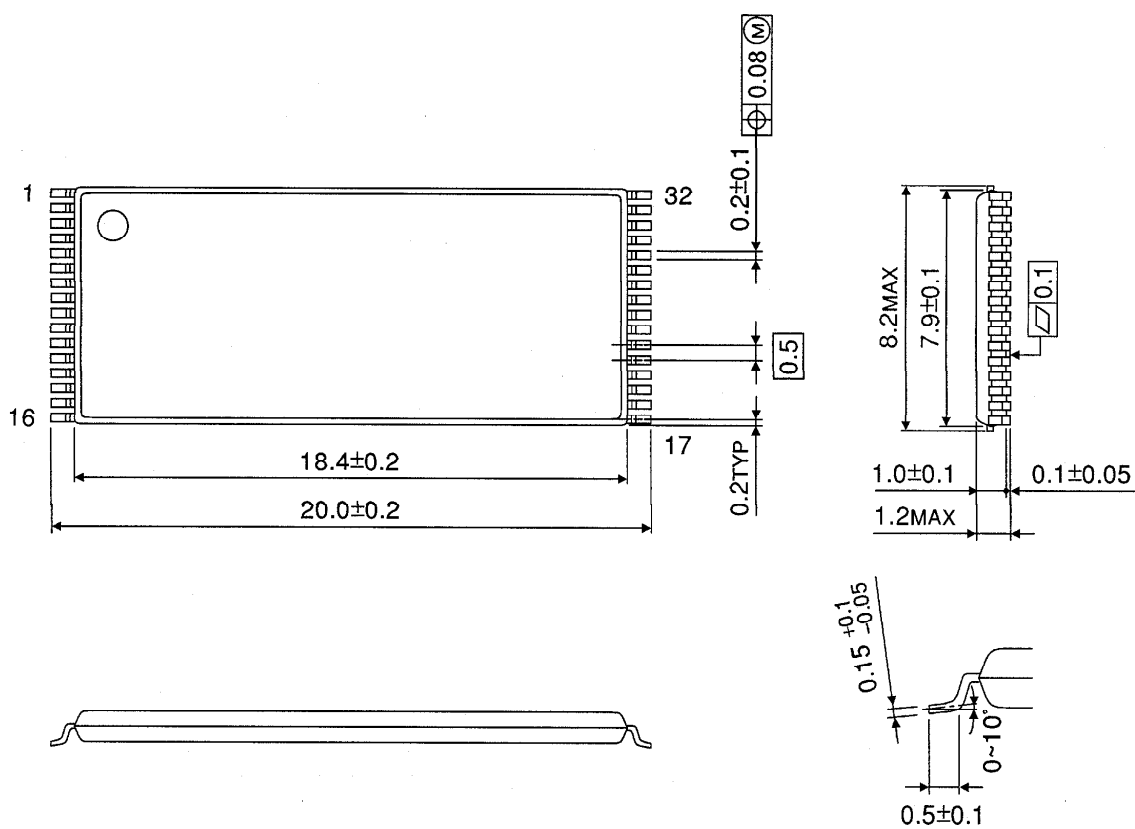
Units in mm



Weight: 1.04 g (typ)

**PACKAGE DIMENSIONS (TSOP I 32-P-0820-0.50)**

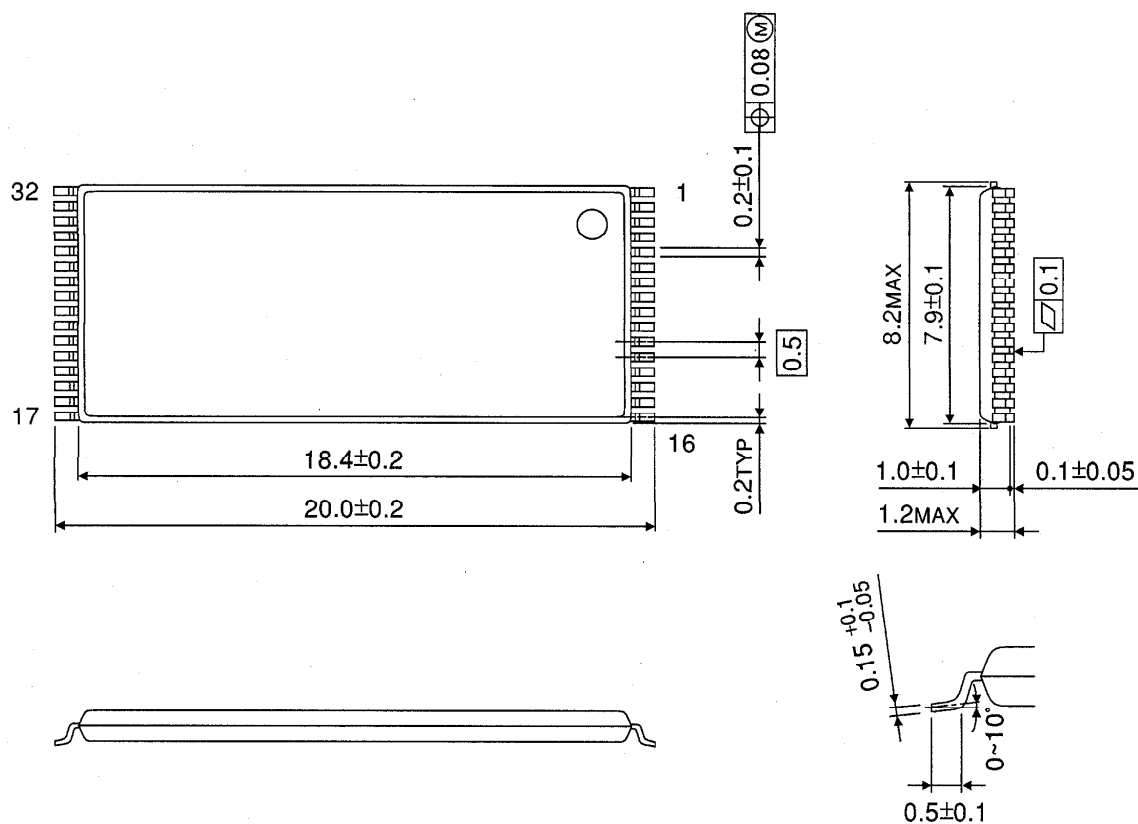
Units in mm



Weight: 0.34 g (typ)

**PACKAGE DIMENSIONS (TSOP I 32-P-0820-0.50A)**

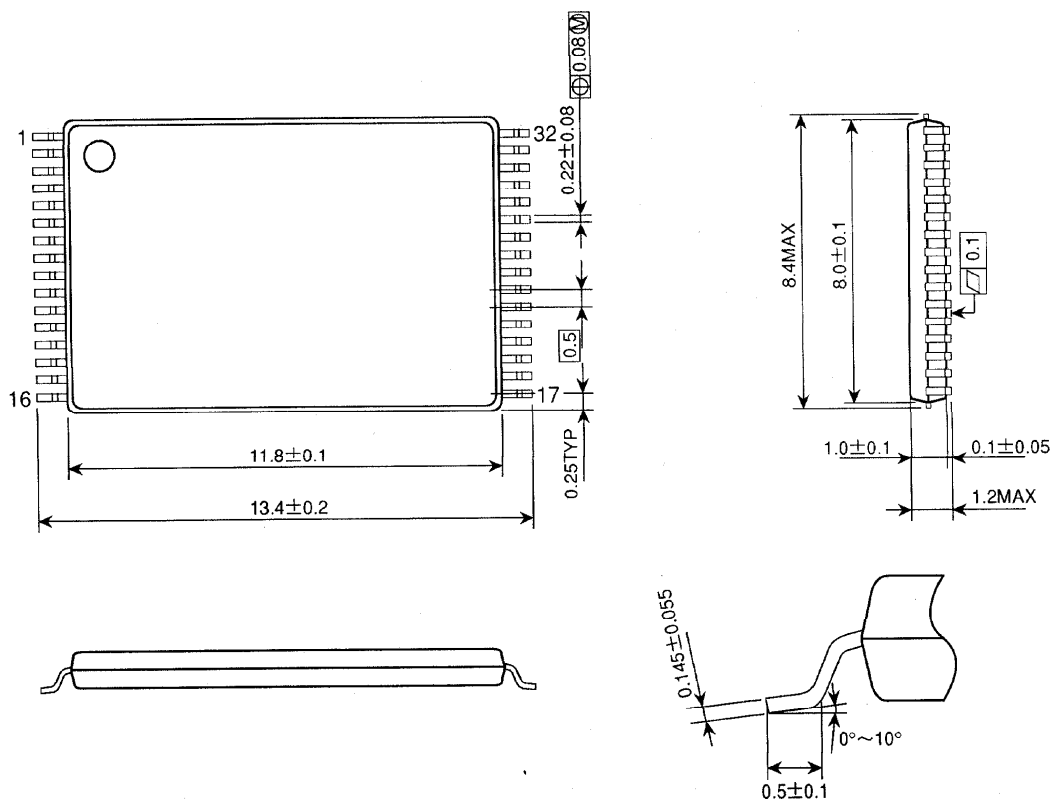
Units in mm



Weight: 0.34 g (typ)

**PACKAGE DIMENSIONS (TSOP I 32-P-0.50)**

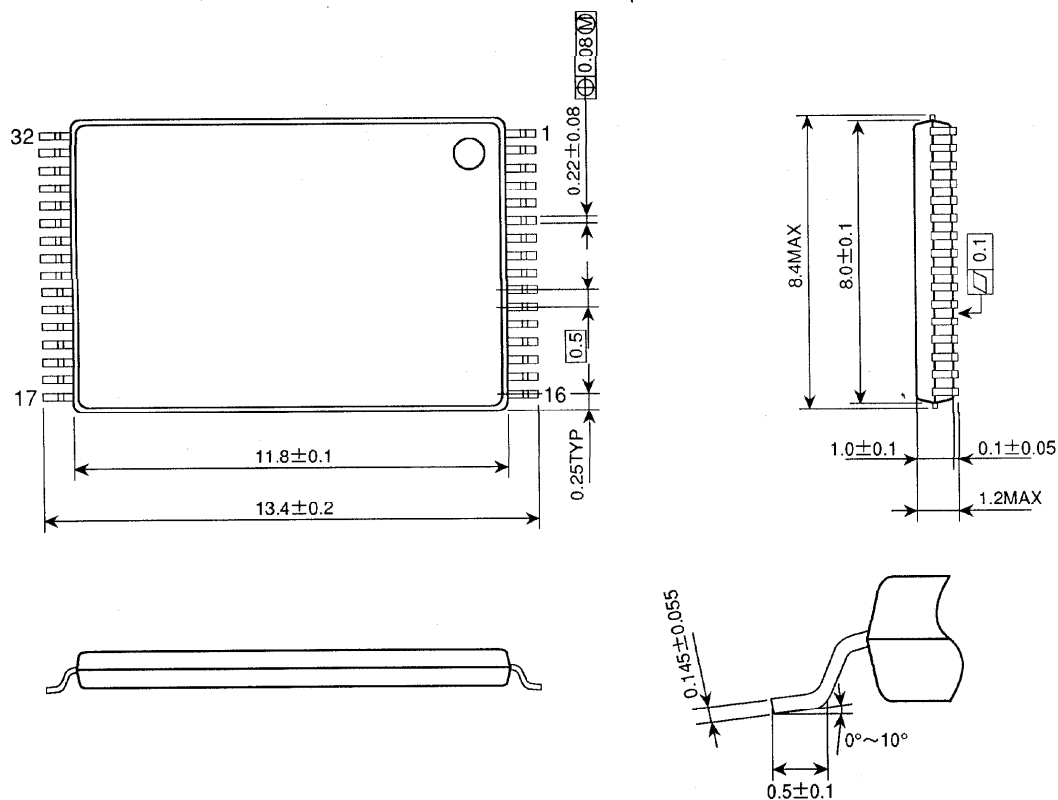
Units in mm



Weight: 0.24 g (typ)

**PACKAGE DIMENSIONS (TSOP I 32-P-0.50A)**

Units in mm



Weight: 0.24 g (typ)